# LCD / LCM SPECIFICATION



WINSTAR Display Co.,Ltd. 華凌光電股份有限公司

# Winstar Display Co., LTD 華凌光電股份有限公司



WEB: <a href="https://www.winstar.com.tw">https://www.winstar.com.tw</a> E-mail: sales@winstar.com.tw

### **SPECIFICATION**

MODULE NO.:	WG12864M-TFH-V#N
CUSTOMER :	۸ (۱۰)

APPROVED	BY:
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(FOR CUSTOMER USE ONLY)

**PCB VERSION:** 

DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
(5)	>		

VERSION	DATE	REVISED	SUM	IMARY
		PAGE NO.		
L	2023/04/19		Modify Information	Backlight (Note)



MODLE NO:

華凌光電股份有限公司

### **RECORDS OF REVISION**

DOC. FIRST ISSUE

VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2007/08/20		First issue
A	2008/08/26		Modify backlight
			information.
В	2008/11/24		Modify backlight
			information.
C	2009/06/22		Modify Timing
		40	Characteristics
D	2013/04/19		Remove ic information
Е	2013/06/06		Correct VIH=0.7VDD
F	2016/01/27		Modify Precautions in use
			of LCD Modules
			& Static electricity test
G	2016/04/19		Modify Response Time
H	2017/02/24		Modify Backlight
			Information
I	2019/08/27		Modify Material List of
			Components for RoHs
J	2019/12/17		Modify Precautions in use
			of LCD Modules
K	2021/01/12		Add Interface

L	2023/04/19	Modify Backlight
		Information(Note)

### **Contents**

- 1.Module Classification Information
- 2.Precautions in use of LCD Modules
- 3.General Specification
- 4. Absolute Maximum Ratings
- 5. Electrical Characteristics
- 6. Optical Characteristics
- 7.Interface Pin Function
- 8. Contour Drawing & Block Diagram
- 9.Reliability
- 10.Backlight Information
- 11.Inspection specification
- 12. Material List of Components for RoHs
- 13.Recommendable Storage

### 1. Module Classification Information

① Brand: WINSTAR DISPLAY CORPORATION

② Display Type: H→Character Type, G→Graphic Type, X→TAB Type, O→COG Type

③ Display Font: 128 \* 64 dot

Model serials no.

© Backlight Type: N $\rightarrow$ Without backlight T $\rightarrow$ LED, White L $\rightarrow$ LED, Full color

 $B\rightarrow EL$ , Blue green  $A\rightarrow LED$ , Amber  $J\rightarrow DIP$  LED, Blue  $D\rightarrow EL$ , Green  $R\rightarrow LED$ , Red  $K\rightarrow DIP$  LED, White

W→EL, White O→LED, Orange E→DIP LED, Yellow Green

 $M\rightarrow$ EL, Yellow Green  $G\rightarrow$ LED, Green  $H\rightarrow$ DIP LED, Amber  $F\rightarrow$ CCFL, White  $P\rightarrow$ LED, Blue  $I\rightarrow$ DIP LED, Red

 $Y \rightarrow LED$ , Yellow Green  $X \rightarrow LED$ , Dual color  $G \rightarrow LED$ , Green  $C \rightarrow LED$ , Full color

© LCD Mode : B→TN Positive, Gray V→FSTN Negative, Blue

N→TN Negative, T→FSTN Negative, Black

L→VA Negative D→FSTN Negative (Double film)

 $H \rightarrow HTN$  Positive, Gray  $F \rightarrow FSTN$  Positive  $I \rightarrow HTN$  Negative, Black  $K \rightarrow FSC$  Negative  $U \rightarrow HTN$  Negative, Blue  $S \rightarrow FSC$  Positive

M→STN Negative, Blue E→ISTN Negative, Black
G→STN Positive, Gray C→CSTN Negative, Black
Y→STN Positive, Yellow Green A→ASTN Negative, Black

② LCD Polarize A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

Type/ Temperature D→Reflective, N.T, 12:00 K→Transflective, W.T,12:00 range/ View G→Reflective, W. T, 6:00 C→Transmissive, N.T,6:00 direction J→Reflective, W. T, 12:00 F→Transmissive, N.T,12:00

B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00 E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

Special Code
V : Build in Negative voltage

#:Fit in with the ROHS Directions and regulations

N:NT7107, NT7108

### 2.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

# **3.General Specification**

Item	Dimension	Unit		
Number of dots	128 x 64 dots	_		
Module dimension	95.5x 50.2 x 13.6(MAX)	mm		
View area	72.0 x 40.0	mm		
Active area	66.52 x 33.24	mm		
Dot size	0.48 x 0.48	mm		
Dot pitch	0.52 x 0.52	mm		
LCD type	FSTN Positive Transflective  (In LCD production, It will occur slightly color can only guarantee the same color in the same b			
Duty	1/64			
View direction	6 o'clock			
Backlight Type	LED ,White	LED ,White		
IC	NT7107, NT7108			
Interface	68 series			

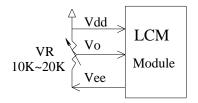
# **4.Absolute Maximum Ratings**

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	$T_{OP}$	-20	_	+70	$^{\circ}$ C
Storage Temperature	$T_{ST}$	-30	_	+80	$^{\circ}\!\mathbb{C}$
Supply Voltage For Logic	$V_{DD}$ - $V_{SS}$	-0.3	_	7.0	V
Driver Supply Voltage	$V_{LCD}$	V <sub>EE</sub> -0.3	_	V <sub>DD</sub> +0.3	V

# **5.Electrical Characteristics**

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Supply Voltage For Logic	$V_{DD}$ - $V_{SS}$	_	4.5	5.0	5.5	V
Supply Voltage For		Ta=-20°C	_	_	10.6	V
LCD	$V_{DD}$ - $V_{O}$	Ta=25°C	8.8	9.1	9.4	V
*Note		Ta=70°C	8.4	_		V
Input High Volt.	$V_{\mathrm{IH}}$	_	$0.7~V_{DD}$	_	$V_{ m DD}$	V
Input Low Volt.	$V_{IL}$	_	0		0.8	V
Output High Volt.	$V_{\mathrm{OH}}$	_	2.4		_	V
Output Low Volt.	$V_{OL}$	_		_	0.4	V
Supply Current	$I_{DD}$	V <sub>DD</sub> =5.0V		2.5	7.5	mA

<sup>\*</sup> Note: Please design the VOP adjustment circuit on customer's main board

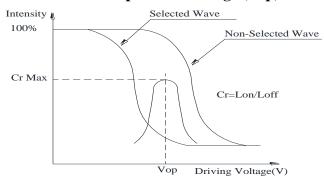


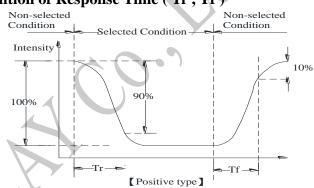
## **6.Optical Characteristics**

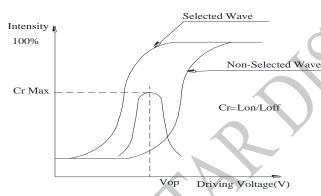
Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR≧2	0	_	30	$\phi = 180^{\circ}$
V A1-	θ	CR≧2	0	_	60	$\phi = 0^{\circ}$
View Angle	θ	CR≧2	0	_	45	$\phi = 90^{\circ}$
	θ	CR≧2	0	_	45	$\phi = 270^{\circ}$
Contrast Ratio	CR	_	_	5	_	_
Response Time	T rise	_	_	200	300	ms
	T fall	_	—	250	350	ms

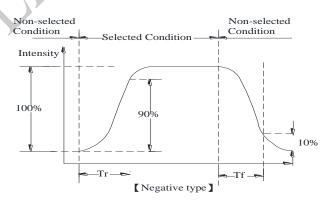
### **Definition of Operation Voltage (Vop)**

## **Definition of Response Time (Tr, Tf)**









#### **Conditions:**

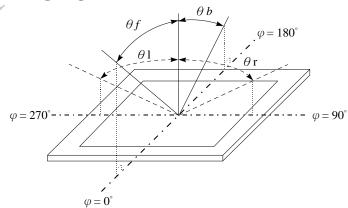
Operating Voltage: Vop

Viewing Angle( $\theta$ ,  $\varphi$ ):  $0^{\circ}$ ,  $0^{\circ}$ 

Frame Frequency: 64 HZ

Driving Waveform: 1/N duty, 1/a bias

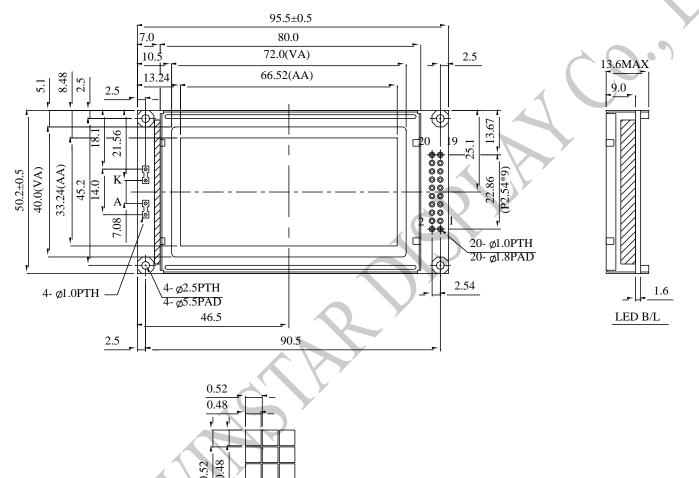
### Definition of viewing angle $(CR \ge 2)$



# **7.Interface Pin Function**

Pin No.	Symbol	Level	Description
1	V <sub>SS</sub>	0V	GND
2	$V_{\mathrm{DD}}$	5.0V	Power Supply
3	Vo	(Variable)	Contrast Adjustment
4	D/I	H/L	Data /Instruction
5	R/W	H/L	Data Read/Write
6	Е	Н	H→L Enable signal
7	DB0	H/L	Data bus line
8	DB1	H/L	Data bus line
9	DB2	H/L	Data bus line
10	DB3	H/L	Data bus line
11	DB4	H/L	Data bus line
12	DB5	H/L	Data bus line
13	DB6	H/L	Data bus line
14	DB7	H/L	Data bus line
15	CS1	H	Chip Select for IC1
16	CS2	Н	Chip Select for IC2
17	/RST	L	Reset
18	Vee	_	Negative Voltage output
19	A	_	LED+
20	K	_	LED-

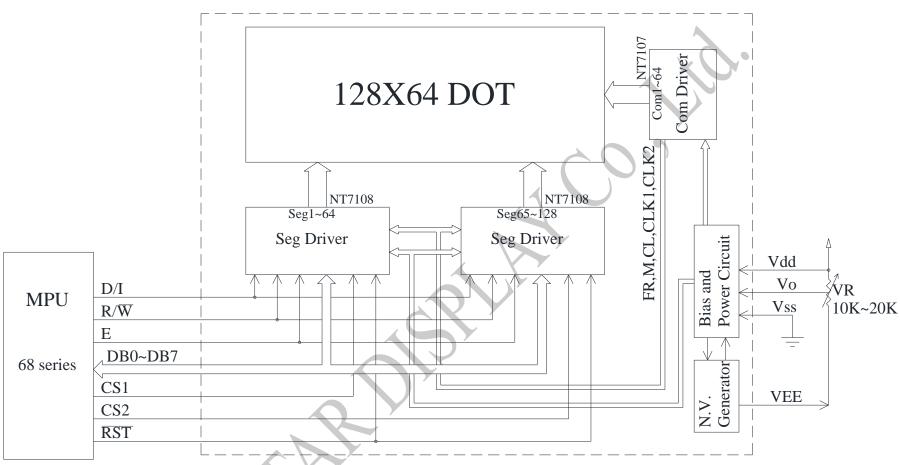
# **8.Contour Drawing & Block Diagram**



PIN NO.	SYMBOL
1	Vss
2	Vdd
3	Vo
4	D/I
5	R/W
6	Е
7	DB0
8	DB1
9	DB2
10	DB3
11	DB4
12	DB5
13	DB6
14	DB7
15	CS1
16	CS2
17	RST
18	VEE
19	A
20	K

The non-specified tolerance of dimension is  $\pm 0.3 \ \text{mm}$  .

DOT SIZE SCALE 10/1



External contrast adjustment.

## 9.Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

	Environmental Test				
Test Item	Content of Test	Test Condition	Not e		
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs ▲	2		
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2		
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs			
Low Temperature Operation					
High Temperature/ Humidity storage	The module should be allowed to stand at 60 °C,90% RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2		
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation  -20°C 25°C 70°C  30min 5min 30min 1 cycle	-20°C/70°C 10 cycles			
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3		
Static electricity test	Endurance test applying the electric stress to the terminal.	VS= $\pm 600$ V(contact), $\pm 800$ v(air), RS= $330\Omega$ CS= $150$ pF 10 times			

Note1: No dew condensation to be observed.

Note 2: The function test shall be conducted after 4 hours storage at the normal  ${\bf r}$ 

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

## **10.Backlight Information**

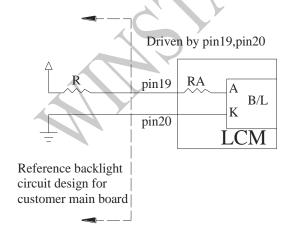
### **Specification**

Parameter	Symbol	Min	Тур	Max	Unit	Test Condition
Supply Current	ILED	20	64	80	mA	V=3.5V(Note 1)
Supply Voltage	V	3.4	3.5	3.6	V	-
Reverse Voltage	VR	_	_	5	V	- KO
Luminance (Without LCD)	IV	760	950	_	cd/m <sup>2</sup>	V=3.5V
LED Life Time (For Reference only)	_	_	50K	- /	Hr.	ILED=64mA 25°C,50-60%RH, (Note 2)
Color	White					1

Note: A backlight driven by voltage will keep the drive current under the safe area (current between minimum and maximum).

If the B/L LED is driven by current only, the drive voltage cannot be considered as a reference value.

Note 1: Supply current minimum value is only for reference since LED brightness efficiency keeps enhancing. Current consumption becomes less and less to achieve the same luminance. Note 2:50K hours is only an estimate for reference.



# 11.Inspection specification

Electrical	•		al segment, segment	contrast defect.				
	_	r, dot or						
	Display malfunct	Missing character, dot or icon.						
		tion.						
	No function or no display.							
Testing	Current consump	otion exce	eeds product specific	cations.	0.65			
	LCD viewing ang	gle defec	t.					
	Mixed product ty	pes.			<b>Y</b>			
	Contrast defect.							
Black or white	2.1 White and bla	ack spots	on display $\leq 0.25 \text{m}$	nm, no more than				
spots on LCD	three white or black spots present.				2.5			
(display only)	2.2 Densely spaced: No more than two spots or lines within 3mm							
	3.1 Round type:	As follow	wing drawing					
	$\Phi = (x + y) / 2$							
	. X	i [	Sizo	Accontable OTV				
	→ <u></u>	L A		-	2.5			
	7	rY			2.3			
LCD black spots,		T .						
white spots,			*	-				
contamination				0				
(non-display)	3.2 Line type : ( <i>A</i>	As follow	ing drawing)					
		Length	Width	Acceptable Q TY				
	○ /¥w		W≦0.02	Accept no dense	2.5			
	→ı <sub>L</sub> 1←	L≦3.0	$0.02 < W \le 0.03$	2	2.3			
		L≦2.5	$0.03 < W \le 0.05$	2				
			0.05 < W	As round type				
	If bubbles are vis	sible,	Size Φ	Acceptable Q TY				
	judge using black	k spot	$\Phi \leq 0.20$	Accept no dense				
Polarizer bubbles	specifications, no	ot easy	$0.20 < \Phi \leq 0.50$	3	2.5			
	to find, must che	ck in	$0.50 < \Phi \le 1.00$	2				
	specify direction.		1.00 < Ф	0				
			Total Q TY	3				
	cD black spots, white spots, contamination (non-display)	Mixed product ty Contrast defect.  Black or white spots on LCD (display only)  3.1 Round type: Φ=(x+y)/2  X  CD black spots, white spots, contamination (non-display)  3.2 Line type: (A  If bubbles are vis judge using black specifications, not to find, must che	Mixed product types. Contrast defect.  2.1 White and black spots three white or black spots 2.2 Densely spaced: No mage and type: As follow Φ=(x+y)/2  The spots, white spots, contamination (non-display)  3.2 Line type: (As follow Length ————————————————————————————————————	Contrast defect.  Black or white spots on LCD (display only)  2.1 White and black spots on display $\leq 0.25$ m three white or black spots present.  2.2 Densely spaced: No more than two spots of three white or black spots present.  2.2 Densely spaced: No more than two spots of three white or black spots present.  2.2 Densely spaced: No more than two spots of three white or black spots present.  2.2 Densely spaced: No more than two spots of three white or black spots present.  2.2 Densely spaced: No more than two spots of three white or black spots present.  2.2 Densely spaced: No more than two spots of three white or black spots present.  2.2 Densely spaced: No more than two spots of three white or black spots present.  2.2 Densely spaced: No more than two spots of three white or black spots present.  2.2 Densely spaced: No more than two spots of three white or black spots present.  2.2 Densely spaced: No more than two spots of three white or black spots present.  2.2 Densely spaced: No more than two spots of three white or black spots present.  2.2 Densely spaced: No more than two spots of three white or black spots present.  2.2 Densely spaced: No more than two spots of three white or black spots present.  2.2 Densely spaced: No more than two spots of three white or black spots present.  2.2 Densely spaced: No more than two spots of three white or black spots present.  2.2 Densely spaced: No more than two spots of three white or black spots of the present present.  2.2 Densely spaced: No more than two spots of three white or black spots of the present present.  2.2 Densely spaced: No more than two spots of the present present present.  2.2 Densely spaced: No more than two spots of the present pre	Mixed product types. Contrast defect.  Black or white spots on LCD (display only)  2.1 White and black spots on display $\leq 0.25$ mm, no more than three white or black spots present.  2.2 Densely spaced: No more than two spots or lines within 3mm  3.1 Round type : As following drawing $\Phi = (x + y) / 2$ Size Acceptable QTY $\Phi \leq 0.10  \text{Accept no dense}$ $0.10 < \Phi \leq 0.20  2$ $0.20 < \Phi \leq 0.25  1$ $0.25 < \Phi  0$ 3.2 Line type : (As following drawing)  Length Width Acceptable Q TY $\Psi \leq 0.02  \text{Accept no dense}$ $1. \leq 3.0  0.02 < \Psi \leq 0.03  2$ $1. \leq 2.5  0.03 < \Psi \leq 0.03  2$ $1. \leq 2.5  0.03 < \Psi \leq 0.05  2$ $1. \leq 2.5  0.03 < \Psi \leq 0.05  3$ $1. \leq 2.5  0.03 < \Psi \leq 0.05  3$ Using black spot specifications, not easy to find, must check in specify direction.			

No	Item		Criterion		AQL
05	Scratches	Follow NO.3 LCD blac	k spots, white spots, cor	ntamination	
		Symbols Define: x: Chip length y: k: Seal width t: L: Electrode pad length 6.1 General glass chip: 6.1.1 Chip on panel surf	Chip width z: Chi Glass thickness a: LC	p thickness D side length  panels:  x: Chip length	
06	Chipped glass	$Z \leq 1/2t$ $1/2t < z \leq 2t$	area Not exceed 1/3k	$x \le 1/8a$ $x \le 1/8a$	2.5
		⊙ If there are 2 or more 6.1.2 Corner crack:	chips, x is total length of	of each chip.	
		z: Chip thickness	y: Chip width	x: Chip length	
		Z≦1/2t	Not over viewing area	x ≤ 1/8a	
	1	$1/2t < z \leq 2t$	Not exceed 1/3k	$x \le 1/8a$	
		⊙ If there are 2 or more	chips, x is the total leng	gth of each chip.	

No	Item			Criteri	ion		AQL
		Symbols:					
		x: Chip length	y: Chip w	idth	z: Chi	p thickness	
		k: Seal width	t: Glass th	ickness	a: LCl	D side length	
		L: Electrode pad ler	igth				
		6.2 Protrusion over	terminal :				
		6.2.1 Chip on electr	ode pad :				
	Glass	y: Chip width $y \le 0.5 \text{mm}$ 6.2.2 Non-conductive		Chip leng $x \le 1/8a$	Z gth	$\begin{array}{c c} \textbf{z: Chip thickness} \\ 0 < z \leq t \end{array}$	2.5
06	crack	У	↑ z	у	T.	↑ Z	2.5
		y: Chip width	X:	Chip leng	gth	z: Chip thickness	
		$y \leq L$		$x \le 1/8a$		$0 < z \le t$	
						over 2/3 of the ITO must terminal specifications.	
						mer, the alignment mark not	
		be damaged.					
		6.2.3 Substrate prot	uberance an	d internal	crack.		
				y:	width	x: length	
				<b>y</b> ≦	≤ 1/3L	$x \leq a$	
~		y X				<u>,                                      </u>	

No	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
		8.1 Illumination source flickers when lit.	0.65
00	Backlight	8.2 Spots or scratched that appear when lit must be judged. Using	2.5
08	elements	LCD spot, lines and contamination standards.	
		8.3 Backlight doesn't light or color wrong.	0.65
		9.1 Bezel may not have rust, be deformed or have fingerprints,	2.5
09	Bezel	stains or other contamination.	
		9.2 Bezel must comply with job specifications.	0.65
		10.1 COB seal may not have pinholes larger than 0.2mm or	2.5
		contamination.	
		10.2 COB seal surface may not have pinholes through to the IC.	2.5
		10.3 The height of the COB should not exceed the height	0.65
		indicated in the assembly diagram.	
		10.4 There may not be more than 2mm of sealant outside the seal	2.5
		area on the PCB. And there should be no more than three places.	
		10.5 No oxidation or contamination PCB terminals.	
		10.6 Parts on PCB must be the same as on the production	2.5
10	PCB、COB	characteristic chart. There should be no wrong parts, missing	0.65
		parts or excess parts.	
		10.7 The jumper on the PCB should conform to the product	
		characteristic chart.	0.65
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or	
		screw hold pad, make sure it is smoothed down.	2.5
		10.9 The Scraping testing standard for Copper Coating of PCB	
			2.5
		X	
	4	$X * Y \le 2mm^2$	
	A	11.1 No un-melted solder paste may be present on the PCB.	2.5
		11.2 No cold solder joints, missing solder connections, oxidation	2.5
11	Soldering	or icicle.	
		11.3 No residue or solder balls on PCB.	2.5
		11.4 No short circuits in components on PCB.	0.65

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface Pin	2.5
		(OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface pin	2.5
		must be present or look as if it cause the interface pin to sever.	
	General	12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12		component) is not burned into brown or black color.	
	appearance	12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

### **12.Material List of Components for**

### **RoHs**

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	Cd	Pb	Hg	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Limited	100	1000	1000	1000	1000	1000	1000	1000	1000	1000
Value	Value ppm ppm ppm ppm ppm ppm ppm ppm ppm pp									
Above limited value is set up according to RoHS.										

- 2.Process for RoHS requirement : (only for RoHS inspection)
  - (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
  - (2) Heat-resistance temp. :

Reflow:  $250^{\circ}$ C, 30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. :  $235\pm5^{\circ}$ C;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

## 13. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.



		Feedback Sheet
odule Number :		Page: 1
1 • Panel Specification :	□ <b>n</b>	
1. Panel Type:	☐ Pass	□ NG ,
2. View Direction:	☐ Pass	□ NG ,
3. Numbers of Dots:	☐ Pass	□ NG ,
4. View Area:	Pass	☐ NG ,
5. Active Area:	☐ Pass	□ NG ,
6. Operating Temperature:	Pass	□ NG ,
7. Storage Temperature:	Pass	□ NG ,
8. Others:		
2 · Mechanical Specification	:	
1. PCB Size:	Pass	□ NG ,
2. Frame Size:	Pass	□ NG ,
3. Materal of Frame:	Pass	□ NG ,
4. Connector Position:	Pass	□ NG ,
5. Fix Hole Position:	Pass	□ NG ,
6. Backlight Position:	☐ Pass	□ NG ,
7. Thickness of PCB:	☐ Pass	☐ NG ,
8. Height of Frame to PCB	: Pass	□ NG ,
9. Height of Module:	Pass	□ NG ,
10. Others:	☐ Pass	□ NG ,
3 · <u>Relative Hole Size</u> :	2	
1. Pitch of Connector:	☐ Pass	☐ NG ,
2. Hole size of Connector:	☐ Pass	□ NG ,
3. Mounting Hole size:	Pass	☐ NG ,
4. Mounting Hole Type:	Pass	☐ NG ,
5. Others:	Pass	☐ NG ,
4 · Backlight Specification :		
1. B/L Type:	Pass	□ NG ,
2. B/L Color:	Pass	☐ NG ,
3. B/L Driving Voltage (Refe	erence for LED T	
4. B/L Driving Current:	Pass	□ NG ,
5. Brightness of B/L:	Pass	□ NG ,
6. B/L Solder Method:	Pass	□ NG ,
7. Others:	☐ Pass	□ NG ,
	>> Go to	page 2 <<

lodu]	winstar le Number:		Page: 2
	Electronic Characteristics of		9
1.	Input Voltage:	Pass	□ NG ,
2.		Pass	□ NG ,
3.	Driving Voltage for LCD:	Pass	□ NG ,
4.	Contrast for LCD:	Pass	□ NG ,
5.	B/L Driving Method:	Pass	□ NG ,
6.	Negative Voltage Output:	Pass	□ NG ,
7.	Interface Function:	Pass	□ NG ,
8.	LCD Uniformity:	Pass	□ NG ,
9.	ESD test:	Pass	□ NG,
10.	Others:	Pass	□ NG ,
6、	Summary :		1